

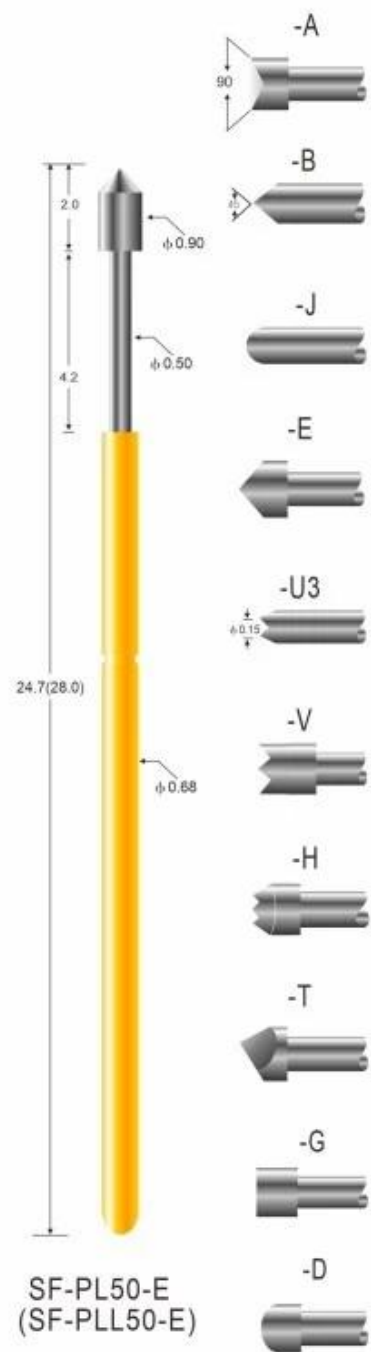
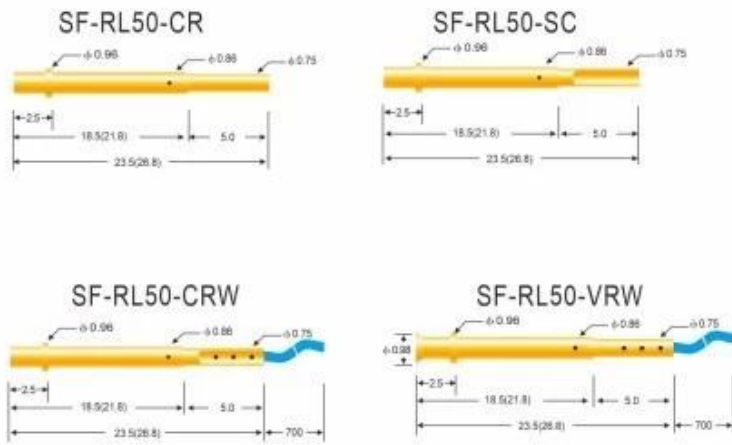


SFENG 1984 XXXXXXXXXX



□□	SF-PL50
□□□□□	1.27mm□.0500"□
□□□□□	V:0.90mm□.0354"□ □□0.95mm□.0374"□
□□□□	4.20□.1654"□
□□□	120□
□□□□□	□□□Be Cu,Rh□□SK4,Rh□□ □□□□□□□□□ □□□□□□
□□□□	3A
□□□□	50□□
□□□	100□
□□□□	□□□□7□□□□





技术规格 PROBE SPECIFICATIONS

Recommended minimum center 最小间距	1.27mm(.0500 ")
Mounting hole size 钻孔尺寸	V: 0.90mm(.0354 ") W: 0.95mm(.0374 ")
Full travel 行程	4.20(.1654 ")
Spring force 弹簧压力	120g(克)
Materials and finishes 材料及涂饰	Plunger:SK4, Ni or Au plated BeCu, Ni or Au plated Barrel:Phosphor bronze, Au plated Spring:Stainless steel
Current ration 额定电流	3A(安培)
Contact resistance 接触电阻	50mΩ(毫欧姆)

Receptacle specifications
Materials and finishes: Phosphor bronze,Gold plated



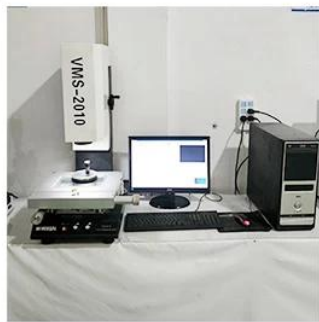
1. 24
2. OEM
- 3.
- 4.



1. PCB ICT FCT
2. Pogo pin
3. BGA
4. QZ VZ LM
- 5.
- 6.
7. 30# OK POM



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope





Q1.□□□□□□□□

A1: □□□□□□□□□□□□□□□□□□□□□□□□□□□□

Q2.□□□□□□□□

A2: □□□□□□□□□□□□□□□□□□□□□□□□□□□□□□□□□□

Q3.□□□□□□

A3: □□□□□□□□□□□□□□□□□□□□□□

Q4.□□□□□□

A4: □□□□□□□□□□□□□□□□□□□□□□□□□□□□

Q5.□□□□□□□□□□□□

A5: [Placeholder]

Q6. [Placeholder]

A6: [Placeholder]

Q7. [Placeholder] **OEM** [Placeholder] **ODM** [Placeholder]

A7: [Placeholder] OEM/ODM [Placeholder]

Q8. [Placeholder]

A8: [Placeholder]